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Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	1.65V ~ 1.95V
Number of Logic Elements/Blocks	32
Number of Macrocells	1024
Number of Gates	-
Number of I/O	381
Operating Temperature	-40°C ~ 105°C (TJ)
Mounting Type	Surface Mount
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc51024mc-75f672i

5000MX. Incoming signals may connect to the global routing pool or the registers in the MFBs. An Output Sharing Array (OSA) increases the number of I/O available to each MFB, allowing a complete function high-performance access to the I/O. There are four clock pins that drive four global clock nets within the device. Two sysCLOCK PLLs are provided to allow the synthesis of new clocks and control of clock skews.

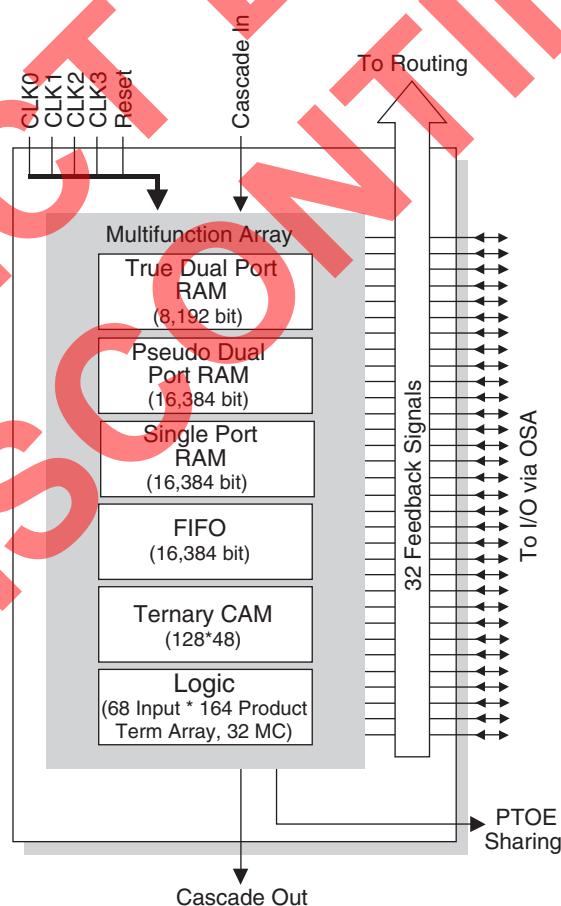
Multi-Function Block (MFB)

Each MFB in the ispXPLD 5000MX architecture can be configured in one of the six following modes. This provides a flexible approach to implementing logic and memory that allows the designer to achieve the mix of functions that are required for a particular design, maximizing resource utilization. The six modes supported by the MFB are:

- SuperWIDE Logic Mode
- True Dual-port SRAM Mode
- Pseudo Dual-port SRAM Mode
- Single-port SRAM Mode
- FIFO Mode
- Ternary CAM Mode

The MFB consists of a multi-function array and associated routing. Depending on the chosen functions the multi-function array uses up to 68 inputs from the GRP and the four global clock and reset signals. The array outputs data along with certain control functions to the macrocells. Output signals can be routed internally for use elsewhere in the device and to the sysIO banks for output. Figure 2 shows the block diagram of the MFB. The various configurations are described in more detail in the following sections.

Figure 2. MFB Block Diagram



True Dual-Port SRAM Mode

In Dual-Port SRAM Mode the multi-function array is configured as a dual port SRAM. In this mode two independent read/write ports access the same 8,192-bits of memory. Data widths of 1, 2, 4, 8, and 16 are supported by the MFB. Figure 9 shows the block diagram of the dual port SRAM.

Write data, address, chip select and read/write signals are always synchronous (registered.) The output data signals can be synchronous or asynchronous. Resets are asynchronous. All inputs on the same port share the same clock, clock enable, and reset selections. All outputs on the same port share the same clock, clock enable, and reset selections. Selections may be made independently between both inputs and outputs and ports. Table 5 shows the possible sources for the clock, clock enable and initialization signals for the various registers.

Figure 9. Dual-Port SRAM Block Diagram

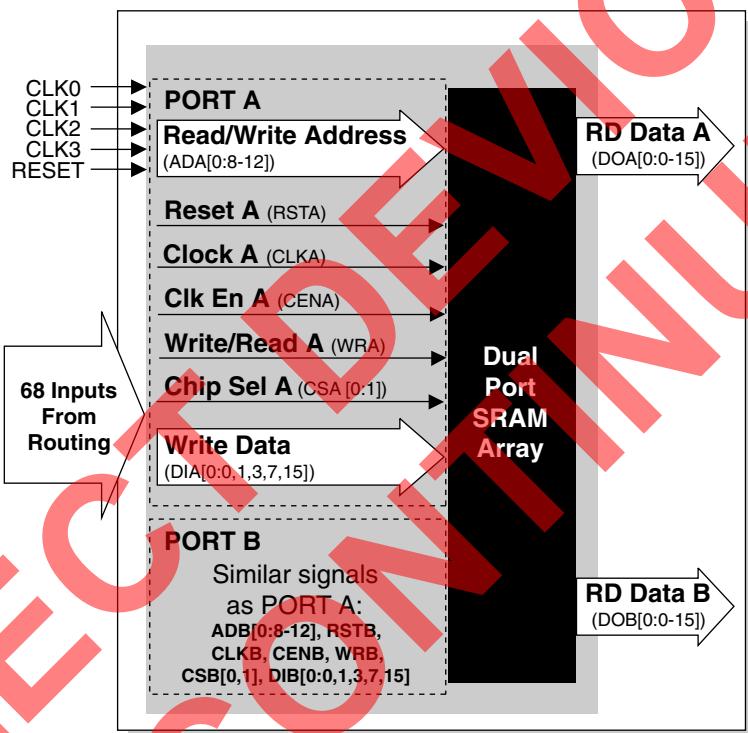


Table 5. Register Clock, Clock Enable, and Reset in Dual-Port SRAM Mode

Register	Input	Source
Address, Write Data, Read Data, Read/Write, and Chip Select	Clock	CLKA (CLKB) or one of the global clocks (CLK0 - CLK3). The selected signal can be inverted if desired.
	Clock Enable	CENA (CENB) or one of the global clocks (CLK1 - CLK 2). The selected signal can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RSTA (RSTB). RSTA (RSTB) can be inverted if desired.

CAM Mode

In CAM Mode the multi-function array is configured as a Ternary Content Addressable Memory (CAM). CAM behaves like a reverse memory where the input is data and the output is an address. It can be used to perform a variety of high-performance look-up functions. As such, CAM has two modes of operation. In write or update mode the CAM behaves as a RAM and data is written to the supplied address. In read or compare operations data is supplied to the CAM and if this matches any of the data in the array the Match and Multiple Match (if there is more than one match) flags are set to true and the lowest address with matching data is output. The CAM contains 128 entries of 48 bits. Figure 13 shows the block diagram of the CAM.

To further enhance the flexibility of the CAM a mask register is available. If enabled during updates, bits corresponding with those set to 1 in the mask register are not updated. If enabled during compare operations, bits corresponding to those set to 1 in the mask register are not included in the compare. A write don't care signal allows don't cares to be programmed into the CAM if desired. Like other write operations the mask register controls this.

The write/comp data, write address, write enable, write chip select, and write don't care signals are synchronous. The CAM Output signals, match flag, and multimatch flag can be synchronous or asynchronous. The Enable mask register input is not latched but must meet setup and hold times relative to the write clock. All inputs must use the same clock and clock enable signals. All outputs must use the same clock and clock enable signals. Reset is common for both inputs and outputs. Table 9 shows the allowable sources for clock, clock enable, and reset for the various CAM registers.

Figure 13. CAM Mode

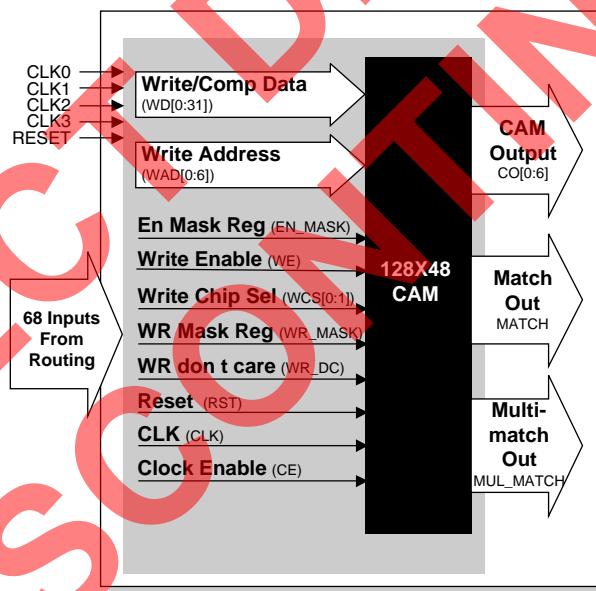
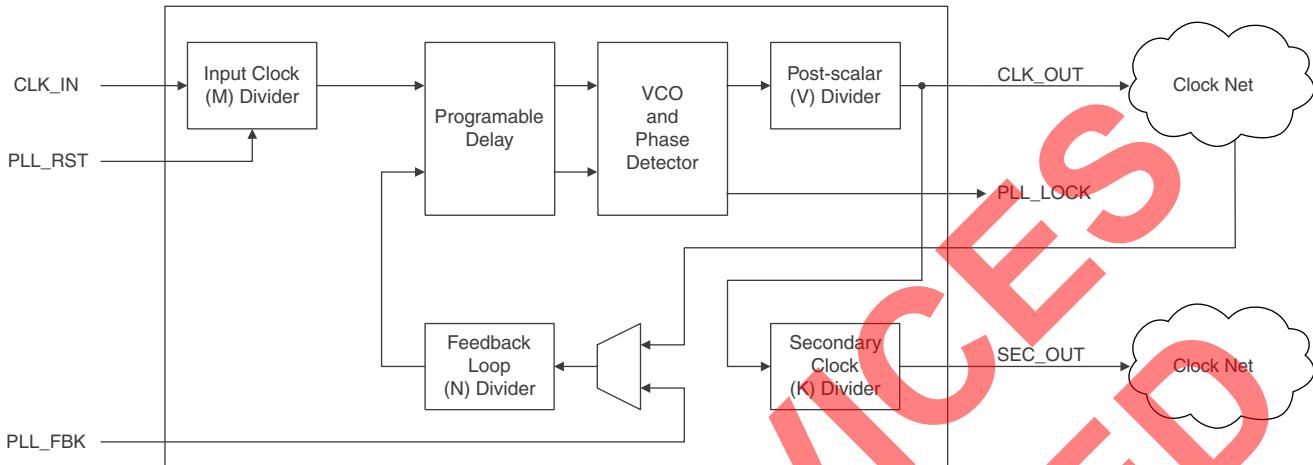
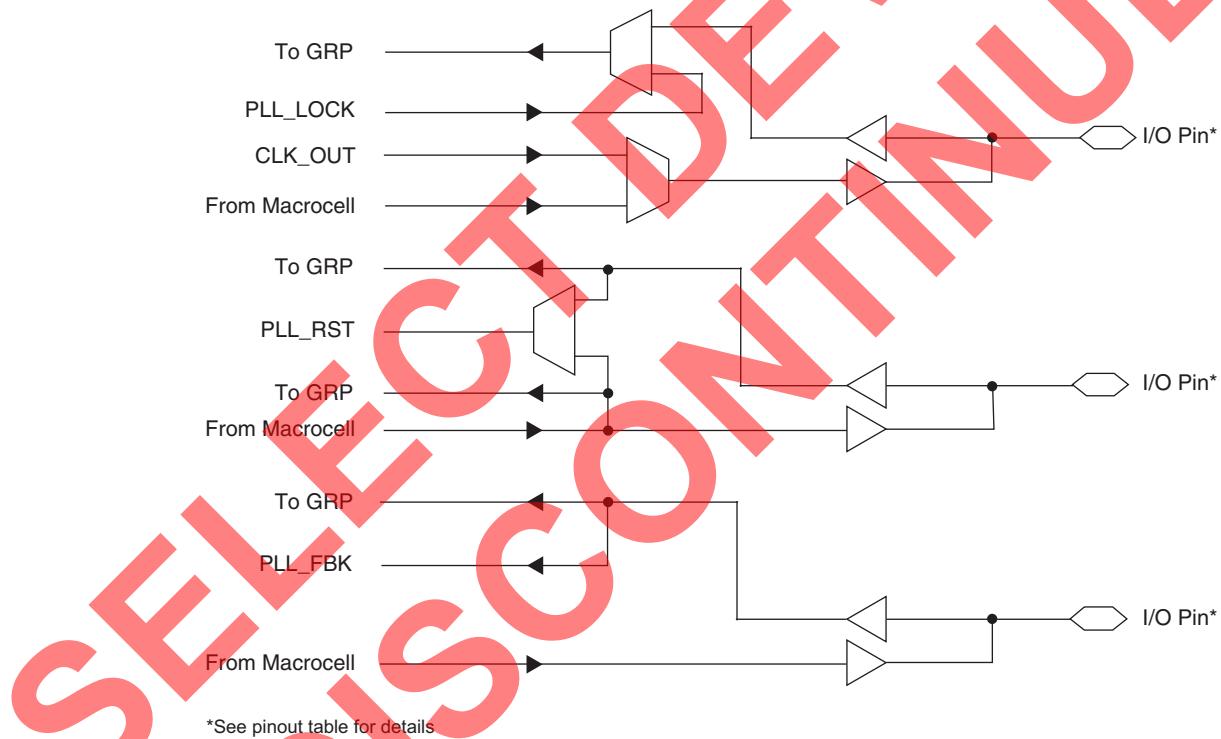


Table 9. Register Clocks, Clock Enables, and Initialization in CAM Mode

Register	Input	Source
Write data, Write address, Enable mask register, Write enable, write chip select, and write don't care, CAM Output, Match, and Multimatch	Clock	CLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	WE or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RST. RST is routed by the multifunction array from GRP, with inversion if desired

Figure 15. PLL Block Diagram**Figure 16. Connection of Optional PLL Inputs and Outputs**

*See pinout table for details

In order to facilitate the multiply and divide capabilities of the PLL, each PLL has dividers associated with it: M, N and K. The M divider is used to divide the clock signal, while the N divider is used to multiply the clock signal. The K divider is only used when a secondary clock output is needed. This divider divides the primary clock output and feeds to a separate global clock net. The V divider is used to provide lower frequency output clocks, while maintaining a stable, high frequency output from the PLL's VCO circuit. The PLL also has a delay feature that allows the output clock to be advanced or delayed to improve set-up and clock-to-out times for better performance. For more information on the PLL, please refer to TN1003, [sysCLOCK PLL Usage Guide for ispXPGA, ispGDX2, ispXPLD and ispMACH 5000VG Devices](#).

sysIO Differential DC Electrical Characteristics

Over Recommended Operating Conditions

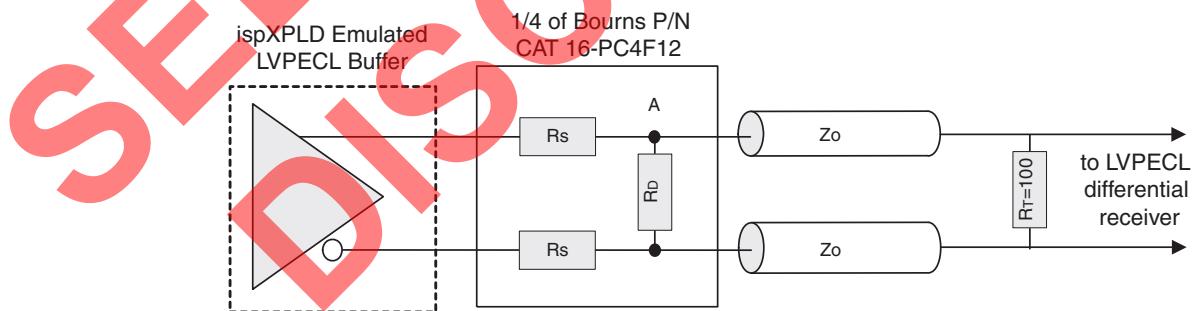
Parameter	Description	Test Conditions	Min.	Typ.	Max.
LVDS					
V_{INP}	Input Voltage		0V	—	2.4V
V_{THD}	Differential Input Threshold	$0.2 \leq V_{CM} \leq 1.8V$	$+/-100mV$	—	—
I_{IN}	Input Current	Power On	—	—	$+/-10\mu A$
V_{OH}	Output High Voltage for V_{OP} or V_{OM}	$RT = 100 \text{ Ohm}$	—	1.38V	1.60V
V_{OL}	Output Low Voltage for V_{OP} or V_{OM}	$RT = 100 \text{ Ohm}$	0.9V	1.03V	—
V_{OD}	Output Voltage Differential	$(V_{OP} - V_{OM}), R_T = 100 \text{ Ohm}$	250mV	350mV	450mV
ΔV_{OD}	Change in V_{OD} Between High and Low		—	—	50mV
V_{OS}	Output Voltage Offset	$(V_{OP} - V_{OM})/2, R_T = 100 \text{ Ohm}$	1.125V	1.20V	1.375V
ΔV_{OS}	Change in V_{OS} Between H and L		—	—	50mV
I_{OSD}	Output Short Circuit Current	$V_{OD} = 0V$ Driver outputs shorted	—	—	24mA

LVPECL¹								
DC Parameter	Parameter Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
V_{CCO}		3.0	3.3	3.0	3.3	3.6	3.6	V
V_{IH}	Input Voltage High	1.49	2.72	1.49	2.72	1.49	2.72	V
V_{IL}	Input Voltage Low	0.86	2.125	0.86	2.125	0.86	2.125	V
V_{OH}	Output Voltage High	1.7	2.11	1.92	2.28	2.03	2.41	V
V_{OL}	Output Voltage Low	0.96	1.27	1.06	1.43	1.3	1.57	V
V_{DIFF}^2	Differential Input voltage	0.3	—	0.3	—	0.3	—	V

1. These values are valid at the output of the source termination pack as shown above with 100-ohm differential load only (see Figure 19). The V_{OH} levels are 200mV below the standard LVPECL levels and are compatible with devices tolerant of the lower common mode ranges.

2. Valid for $0.2 \leq V_{CM} \leq 1.8V$

Figure 19. LVPECL Driver with Three Resistor Pack



ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t_{CASC}	Additional Delay for PT Cascading between MFBs	—	—	0.71	—	0.80	—	0.89	—	0.92	—	1.33	ns
$t_{CICOMFB}$	Carry Chain Delay, MFB to MFB	—	—	0.35	—	0.39	—	0.44	—	0.46	—	0.66	ns
t_{CICOMC}	Carry Chain Delay, Macro-Cell to Macro-Cell	—	—	0.10	—	0.11	—	0.13	—	0.13	—	0.19	ns
t_{FLAG}	Routing Delay for Extended Function Flags	—	—	2.62	—	2.94	—	3.27	—	3.40	—	4.91	ns
$t_{FLAGEXP}$	Additional Flag Delay when Expanding Data Widths	$t_{FLAGFULL}, t_{FLAGAFULL}, t_{FLAGEMPTY}, t_{FLAGAEMPTY}$	—	2.57	—	2.89	—	3.21	—	3.34	—	4.82	ns
t_{SUM}	Counter Sum Delay	t_{PTSA}	—	0.80	—	0.90	—	1.00	—	1.04	—	1.50	ns
Optional Adjusters													
t_{BLA}	Block Loading Adder	t_{ROUTE}	—	0.04	—	0.04	—	0.05	—	0.05	—	0.07	ns
t_{EXP}	PT Expander Adder	t_{ROUTE}	—	0.53	—	0.60	—	0.66	—	0.69	—	0.99	ns
t_{INDIO}	Additional Delay for the Input Register	t_{INREG}	—	0.50	—	0.56	—	0.63	—	0.65	—	0.94	ns
$t_{PLL_SEC_DELAY}$	Secondary PLL Output Delay	t_{PLL_DELAY}	—	0.91	—	0.91	—	0.91	—	0.91	—	0.91	ns
t_{INEXP}	MFB Input Extender	t_{ROUTE}	—	0.62	—	0.70	—	0.78	—	0.81	—	1.16	ns
Input and Output Buffer Delays													
t_{IOI}	Input Buffer Selection Adder	$t_{GCLK_IN}, t_{IN}, t_{GOE}, t_{RST}$	Refer to sysIO Adjuster Tables										ns
t_{IOO}	Output Buffer Selection Adder	t_{BUF}	Refer to sysIO Adjuster Tables										ns
FIFO													
$t_{FIFOWCLKS}$	Write Data Setup before Write Clock Time	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
$t_{FIFOWCLKH}$	Write Data Hold after Write Clock Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{FIFOCLKSKew}$	Opposite Clock Cycle Delay	—	—	1.40	—	1.40	—	1.76	—	1.76	—	1.83	ns
$t_{FIFOFULL}$	Write Clock to Full Flag Delay	—	—	3.08	—	3.08	—	3.85	—	3.85	—	4.00	ns
$t_{FIFOAFULL}$	Write Clock to Almost Full Flag Delay	—	—	3.08	—	3.08	—	3.86	—	3.86	—	4.01	ns
$t_{FIFOEMPTY}$	Read Clock to Empty Flag Delay	—	—	3.08	—	3.08	—	3.86	—	3.86	—	4.01	ns
$t_{FIFOAEMPTY}$	Read Clock to Almost Empty Flag Delay	—	—	3.08	—	3.08	—	3.86	—	3.86	—	4.01	ns

ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

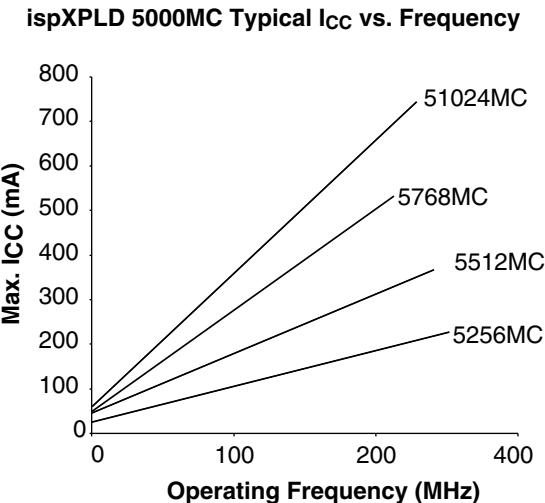
Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.									
t_{DPCEBS}	Clock Enable B Setup before Clock B Time	—	2.33	—	2.33	—	2.33	—	2.33	—	3.03	—	ns
t_{DPCEBH}	Clock Enable Hold B after Clock B Time	—	-2.95	—	-2.95	—	-2.95	—	-2.95	—	-2.27	—	ns
$t_{DPADDBS}$	Address B Setup before Clock B Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
$t_{DPADDBH}$	Address B Hold time after Clock B Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t_{DPRWBS}	R/W B Setup before Clock B Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
t_{DPRWBH}	R/W B Hold time after Clock B Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{DPDATABS}$	Write Data B Setup before Clock B Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
$t_{DPDATABH}$	Write Data B Hold after Clock B Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{DPRCLKAO}$	Read Clock A to Output Delay	—	—	5.97	—	5.92	—	5.86	—	5.65	—	9.86	ns
$t_{DPRCLKBO}$	Read Clock B to Output Delay	—	—	5.16	—	5.16	—	5.16	—	5.16	—	6.71	ns
$t_{DPCLKSKEW}$	Opposite Clock Cycle Delay	—	1.40	—	1.40	—	1.40	—	1.40	—	1.83	—	ns
t_{DPRSTO}	Reset to RAM Output Delay	—	—	3.30	—	3.30	—	3.30	—	3.30	—	4.29	ns
t_{DPRSTR}	Reset Recovery Time	—	1.20	—	1.20	—	1.20	—	1.20	—	1.56	—	ns
$t_{DPRSTPW}$	Reset Pulse Width	—	0.14	—	0.14	—	0.14	—	0.14	—	0.19	—	ns

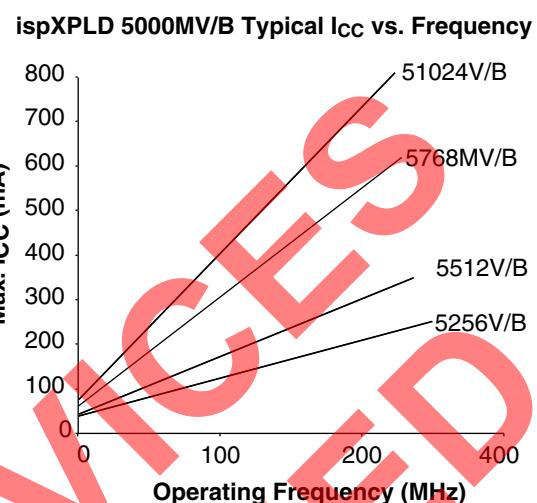
Timing v.1.8

1. The PT-delay to clock of RAM/FIFO/CAM should be t_{BCLK} instead of t_{PTCLK} .
2. The PT-delay to set/reset of RAM/FIFO/CAM should be t_{BSR} instead of t_{PTSR} .

Power Consumption



Note: The device is configured with maximum number of 16-bit counters, no PLL, typical current at 1.8V, 25°C.



Note: The device is configured with maximum number of 16-bit counters, no PLL, typical current at 3.3V (MV) or 2.5V (MB), 25°C.

Power Estimation Coefficients

Device	K0	K1	K2	K3	K4	K5	K6	K7	DC	
	ispXPLD 5000MC	ispXPLD 5000MV/B							ispXPLD 5000MC	ispXPLD 5000MV/B
ispXPLD 5256	2.2	8.4	7	12	100	0.1379	0.0433	6.476	16	24
ispXPLD 5512	2.2	8.4	9.4	18	151	0.1379	0.0433	6.476	17	25
ispXPLD 5768	2.2	8.4	10.2	21	170	0.1379	0.0433	6.476	27	36
ispXPLD 51024	2.2	8.4	13	27.6	200	0.1379	0.0433	6.476	35	43

Note: For further information about the use of these coefficients, refer to TN1031 – [Power Estimation in ispXPLD 5000MX Devices](#).

Memory Coefficients

Device	K8	K9	K10	K11
ispXPLD 5256	0.004719	0.0924	4.4	2.9
ispXPLD 5512	0.004719	0.0924	4.4	2.9
ispXPLD 5768	0.004719	0.0924	4.4	2.9
ispXPLD 51024	0.004719	0.0924	4.4	2.9

- K0 = Current per MFB input ($\mu\text{A}/\text{MHz}$)
- K1 = Current per Product Term ($\mu\text{A}/\text{MHz}$)
- K2 = Current per GRP from MFB ($\mu\text{A}/\text{MHz}$)
- K3 = Current per GRP from I/O ($\mu\text{A}/\text{MHz}$)
- K4 = Global clock tree current ($\mu\text{A}/\text{MHz}$)
- K5 = PLL digital (mA/MHz)
- K6 = PLL analog (mA/MHz)
- K7 = PLL analog baseline (mA)
- DC = Baseline current at 0MHz (mA)
- K8 = CAM frequency component (mA/MHz)
- K9 = CAM DC component (mA)
- K10 = Current per row decoder ($\mu\text{A}/\text{MHz}$)
- K11 = Current per column driver ($\mu\text{A}/\text{MHz}$)

Signal Descriptions

Signal Names	Descriptions
TMS	Input – This pin is the Test Mode Select input, which is used to control the IEEE 1149.1 state machine.
TCK	Input – This pin is the Test Clock input pin, used to clock the IEEE 1149.1 state machine.
TDI	Input – This pin is the IEEE 1149.1 Test Data in pin, used to load data.
TDO	Output – This pin is the IEEE 1149.1 Test Data out pin used to shift data out.
TOE	Input – Test Output Enable pin. TOE tristates all I/O pins when driven low.
GOE0, GOE1	Input – Global output enable inputs.
RESET	Input – This pin resets all the registers in the device. The global polarity for this pin is selectable on a global basis. ^b The default is active low. An external pull-down is required when polarity is set to active high.
yzz	Input/Output – These are the general purpose I/O used by the logic array. y is the MFB reference (alpha) and z is the macrocell reference (numeric) y: A-X (768 macrocells) y: A-P (512 macrocells) y: A-H (256 macrocells) z: 0-31
GND	GND – Ground
NC	No connect
V _{CC}	V _{CC} – The power supply pins for core logic.
V _{CC00} , V _{CC01} , V _{CC02} , V _{CC03}	V _{CC} – The power supply pins for I/O banks 0, 1, 2, and 3.
V _{REF0} , V _{REF1} , V _{REF2} , V _{REF3}	Input – This pin defines the reference voltage for I/O banks 0, 1, 2, and 3.
GCLK0, GCLK1, GCLK2, GCLK3	Input – Global clock/clock enable inputs (see Figure 14 for differential pairing).
CLK_OUT0, CLK_OUT1	Output – Optional clock output from PLL 0 and 1.
PLL_RST0, PLL_RST1	Input – Optional input resets the M divider in PLL 0 and 1.
PLL_FBK0, PLL_FBK1	Input – Optional feedback input for PLL 0 and 1.
GNDP	GND – Ground for PLLs.
V _{CCP}	V _{CC} – The power supply pin for PLLs.
V _{CCJ}	V _{CC} – The power supply for the IEEE 1149.1 interface.
DATAx	I/O – sysCONFIG data pins, bit x.
CSB	Input – sysCONFIG interface chip select. Drive low to select sysCONFIG interface.
CFG0	Input – Defines SRAM configuration mode. Low: sysCONFIG port, high: E ² CMOS or IEEE 1149.1 TAP.
PROGRAMB	Input – Controls the programming of SRAM. Hold high for normal operation. Toggle low to reload SRAM from E ² memory.
CCLK ¹	Input – Clock for sysCONFIG interface. Reads and writes occur on the rising edge of the clock.
READ ¹	Input – Drive high to perform reads from the sysCONFIG interface.
INITB	I/O – Indicates status of configuration. Can be driven low to inhibit configuration.
DONE	Output (open drain) – Indicates status of configuration.

¹. These inputs should not toggle during power up for proper power-up configuration.

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
2	20P	C14	-	-	C15	P11
2	20N	C16/VREF2	-	-	C17	T14
2	21P	C18	C8	D8	C19	R12
2	21N	C20	C9	D9	-	R13
2	22P	C21	C10	D10	-	N11
2	22N	C22	C11	D11	C23	T15
2	23P	C24	C12	D12	C25	R14
2	23N	C26	C13	D13	C27	N12
2	24P	C28	C14	D14	C29	P12
2	24N	C30	C15	D15	C31	R15
-	-	VCCO2	-	-	-	VCCO2
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)
2	25P	D0	-	-	D1	N15
2	25N	D2	-	-	D3	N14
2	26P	D4	C16	D16	-	N16
2	26N	D5	C17	D17	-	M16
2	27P	D6	C18	D18	D7	M14
2	27N	D8	C19	D19	D9	M15
-	-	VCC	-	-	-	VCC
2	28P	D10	C20	D20	D11	L13
2	28N	D12	C21	D21	D13	L12
2	29P	D14	C22	D22	D15	L15
2	29N	D16	C23	D23	D17	L16
-	-	GND	-	-	-	GND
2	30P	D18	C24	D24	D19	L14
-	-	VCCO2	-	-	-	VCCO2
2	30N	D20	C25	D25	-	K15
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)
2	31P	D21	C26	D26	-	K14
2	31N	D22	C27	D27	D23	K12
2	32P	D24	C28	D28	D25	K13
2	32N	D26	C29	D29	D27	J13
2	33P	D28	C30	D30	D29	J14
2	33N	D30	C31	D31	D31	J12
-	-	TOE	-	-	-	J15
-	-	RESET	-	-	-	J11
-	-	GOE0	-	-	-	H11
-	-	GOE1	-	-	-	H13
-	-	GNDP	-	-	-	See Power Supply and NC Connections Table
-	GCLK3N	GCLK2	-	-	-	H15
-	-	V CCP	-	-	-	See Power Supply and NC Connections Table
-	GCLK3P	GCLK3	-	-	-	H16

ispXPLD 5512MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
1	13P	B24	A16	—	B25	—	T4	V6
—	—	V _{CCO1}	—	—	—	57	V _{CCO1}	V _{CCO1}
1	13N	B26	A18	—	B27	—	T5	V7
1	14P	B28	A20	—	B29	—	R4	Y5
1	14N	B30	A22	—	B31	—	N6	AA5
1	15P	C0	—	—	C1	—	R5	Y6
1	15N	C2	—	—	C3	—	P6	Y7
1	16P	C4	—	—	C5	—	—	AA6
1	16N	C8	—	—	C9	—	—	AA7
1	17P	C10	—	—	C11	—	—	W7
1	17N	C12	—	—	C13	—	M7 ¹	V8
1	18P	C16	—	—	C17	—	T6	W8
1	18N	C18	—	—	C19	—	R6	U9
—	—	GND0 (Bank 1)	—	—	—	—	GND (Bank 1)	GND (Bank 1)
—	—	CFG0	—	—	—	58	L8	U10
—	—	V _{CCO1}	—	—	—	—	V _{CCO1}	V _{CCO1}
1	19P	C24	B16	D16	C25	59	T7	AB7
1	19N	C26	B17	D17	C27	60	R7	AA8
1	20P	C28	B18	D18	C29	61	N7	AB8
1	20N	D0	B19	D19	D1	62	P7	AB9
1	21P	D2	B20	D20	D3	63	T8	W9
1	21N	D4	B21	D21	D5	64	R8	Y9
1	22P	D6	B22	D22	D7	65	M8	AB10
1	22N	D8	B23	D23	D9	66	P8	AA10
1	—	D10/V _{REF1}	—	—	D11	67	L9	W10
1	23P	D12	B24	D24	D13	68	N8	Y10
1	23N	D16	B25	D25	D17	69	M9	Y11
—	—	GND (Bank 1)	—	—	—	70	GND (Bank 1)	GND (Bank 1)
1	24P	D18	B26	D26	D19	71	N10	V9
—	—	V _{CCO1}	—	—	—	72	V _{CCO1}	V _{CCO1}
1	24N	D20	B27	D27	D21	73	T9	V10
1	25P	D22	B28	D28	D23	74	T10	AA11
1	25N	D24	B29	D29	D25	75	R9	AB11
—	—	VCC	—	—	—	76	VCC	VCC
1	26P	D26	B30	D30	D27	77	P9	U11
1	26N	D28	B31	D31	D29	78	N9	V11
2	27P	E0	F0	H0	E1	79	T11	AB12
2	27N	E2	F1	H1	E3	80	T12	AA12
—	—	GND	—	—	—	81	NC	GND
—	—	GND	—	—	—	—	GND	GND
2	28P	E4	F2	H2	E5	82	P10	Y12
2	28N	E6	F3	H3	E7	83	R10	AA13
2	29P	E8	F4	H4	E9	84	R11	V12

ispXPLD 5512MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
—	—	V _{CCO2}	—	—	—	85	V _{CCO2}	V _{CCO2}
2	29N	E10	F5	H5	E11	86	M10	U12
—	—	GND (Bank 2)	—	—	—	87	GND (Bank 2)	GND (Bank 2)
2	30P	E12	F6	H6	E13	88	M11	AB13
2	30N	E16	F7	H7	E17	89	T13	Y13
2	31P	E18	—	—	E19	90	P11	V13
2	31N	E20/V _{REF2}	—	—	E21	91	T14	W13
2	32P	E22	F8	H8	E23	92	R12	V14
2	32N	E24	F9	H9	E25	93	R13	W14
2	33P	E26	F10	H10	E27	94	N11	Y14
2	33N	E28	F11	H11	E29	95	T15	AB14
2	34P	F0	F12	H12	F1	96	R14	AB15
2	34N	F2	F13	H13	F3	97	N12	AA15
2	35P	F4	F14	H14	F5	98	P12	U13
—	—	V _{CCO2}	—	—	—	—	V _{CCO2}	V _{CCO2}
2	35N	F6	F15	H15	F7	99	R15	U14
—	—	GND (Bank 2)	—	—	—	—	GND (Bank 2)	GND (Bank 2)
2	36P	F8	E0	—	F9	—	—	W15
2	36N	F10	E2	—	F11	—	—	W16
2	37P	F12	E4	—	F13	—	—	Y16
2	37N	F16	E6	—	F17	—	—	AA16
2	38P	F18	E8	—	F19	—	—	AB16
2	38N	F20	E10	—	F21	—	—	AA17
2	39P	F22	E12	—	F23	—	—	Y17
2	39N	F24	E16	—	F25	—	—	AA18
2	40P	F26	E20	—	F27	—	—	W17
2	40N	F28	E22	—	F29	—	—	W18
2	41P	G0	—	—	G1	—	—	V15
—	—	V _{CCO2}	—	—	—	100	V _{CCO2}	V _{CCO2}
2	41N	G2	—	—	G3	—	—	U15
—	—	GND (Bank 2)	—	—	—	101	GND (Bank 2)	GND (Bank 2)
2	42P	G4	—	—	G5	102	P13	Y18
2	42N	G6	—	—	G7	103	P15	V17
2	43P	G8	—	—	G9	—	M13	V16
2	43N	G10	—	—	G11	—	P14	U16
2	44P	G12	—	—	G13	—	—	AB18
2	44N	G14	—	—	G15	—	—	AB19
2	45P	G16	—	—	G17	—	—	U18
2	45N	G18	—	—	G19	—	—	T17
2	46P	G20	—	—	G21	104	R16	AB20
2	46N	G22	—	—	G23	105	P16	AA20
2	47P	G24	—	—	G25	106	N15	Y19
—	—	V _{CCO2}	—	—	—	107	V _{CCO2}	V _{CCO2}

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
0	143N	U22	U27	W27	U23	—	K6
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	143P	U20	U26	W26	U21	—	K3
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	144N	U18	U25	W25	U19	—	K5
0	144P	U16	U24	W24	U17	—	K2
0	145N	U14	U23	W23	U15	—	L5
0	145P	U12	U22	W22	U13	—	K1
0	146N	U10	U21	W21	U11	—	L6
0	146P	U8	U20	W20	U9	—	L1
0	147N	U6	U19	W19	U7	—	M5
0	147P	U4	U18	W18	U5	—	L2
0	148N	U2	U17	W17	U3	—	N5
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	148P	U0	U16	W16	U1	—	L3
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	149N	W30	U15	W15	W31	—	M6
0	149P	W28	U14	W14	W29	—	M2
0	150N	W26	U13	W13	W27	—	P5
-	-	VCC	-	-	-	VCC	VCC
0	150P	W24	U12	W12	W25	—	P6
0	151N	W22	U11	W11	W23	—	M3
0	151P	W20	U10	W10	W21	—	N6
0	152N	W18	U9	W9	W19	—	N2
0	152P	W16	U8	W8	W17	—	P1
-	-	GND	-	-	-	GND	GND
0	153N	W14	U7	W7	W15	—	N3
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	153P	W12	U6	W6	W13	—	M8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	154N	W10	U5	W5	W11	—	N8
0	154P	W8	U4	W4	-	—	P2
0	155N	W6	U3	W3	W7	—	P8
0	155P	W4	U2	W2	W5	—	N4
0	156N	W2	U1	W1	W3	G2	H1
0	156P	W0	U0	W0	W1	H1	J1
-	GCLK0P	GCLK0	-	-	-	H2	N7
-	-	VCCJ	-	-	-	See Power Supply and NC Connections Table	
-	GCLK0N	GCLK1	-	-	-	J2	P7
-	-	GND	-	-	-	GND	GND
-	-	TDI	-	-	-	H6	R1
-	-	TMS	-	-	-	H4	R2

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
1	-	C28	D14	-	C29	P5	U8
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	15P	C26	D16	-	C27	T4	V6
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	15N	C24	D18	-	C25	T5	V7
-	-	GND	-	-	-	GND	GND
1	16P	C22	D20	-	C23	R4	Y5
-	-	VCC	-	-	-	VCC	VCC
1	16N	C20	D22	-	C21	N6	AA5
1	17P	C18	-	-	C19	R5	Y6
1	17N	C16	-	-	C17	P6	Y7
1	18P	C14	-	-	C15	—	AA6
1	18N	C12	-	-	C13	—	AA7
1	19P	C10	-	-	C11	—	W7
1	19N	C8	-	-	C9	M7	V8
1	20P	C6	-	-	C7	T6	W8
1	20N	C4	-	-	C5	R6	U9
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
-	-	CFG0	-	-	-	L8	U10
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	21P	C0	C16	A16	C1	T7	AB7
1	21N	D30	C17	A17	D31	R7	AA8
1	22P	D28	C18	A18	D29	N7	AB8
1	22N	D26	C19	A19	D27	P7	AB9
1	23P	D24	C20	A20	D25	T8	W9
1	23N	D22	C21	A21	D23	R8	Y9
1	24P	D20	C22	A22	D21	M8	AB10
1	24N	D18	C23	A23	D19	P8	AA10
1	-	D16/VREF1	-	-	D17	L9	W10
1	25P	D14	C24	A24	D15	N8	Y10
1	25N	D12	C25	A25	D13	M9	Y11
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	26P	D10	C26	A26	D11	N10	V9
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	26N	D8	C27	A27	D9	T9	V10
1	27P	D6	C28	A28	D7	T10	AA11
-	-	GND	-	-	-	GND	GND
1	27N	D4	C29	A29	D5	R9	AB11
-	-	VCC	-	-	-	VCC	VCC
1	28P	D2	C30	A30	D3	P9	U11
1	28N	D0	C31	A31	D1	N9	V11
2	29P	E0	F0	H0	E1	T11	AB12
-	-	VCC	-	-	-	VCC	VCC

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
0	175N	AC22	AC27	AE27	AC23	K6	J5
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	175P	AC20	AC26	AE26	AC21	K3	J4
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	176N	AC18	AC25	AE25	AC19	K5	K7
0	176P	AC16	AC24	AE24	AC17	K2	L7
0	177N	AC14	AC23	AE23	AC15	L5	J3
0	177P	AC12	AC22	AE22	AC13	K1	J2
0	178N	AC10	AC21	AE21	AC11	L6	K6
0	178P	AC8	AC20	AE20	AC9	L1	L6
0	179N	AC6	AC19	AE19	AC7	M5	K5
0	179P	AC4	AC18	AE18	AC5	L2	K4
0	180N	AC2	AC17	AE17	AC3	N5	K3
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	180P	AC0	AC16	AE16	AC1	L3	K2
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	181N	AE30	AC15	AE15	AE31	M6	K1
0	181P	AE28	AC14	AE14	AE29	M2	L2
0	182N	AE26	AC13	AE13	AE27	P5	L5
-	-	VCC	-	-	-	VCC	VCC
0	182P	AE24	AC12	AE12	AE25	P6	L4
0	183N	AE22	AC11	AE11	AE23	M3	L3
0	183P	AE20	AC10	AE10	AE21	N6	M3
0	184N	AE18	AC9	AE9	AE19	N2	M7
0	184P	AE16	AC8	AE8	AE17	P1	N7
-	-	GND	-	-	-	GND	GND
0	185N	AE14	AC7	AE7	AE15	N3	M5
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	185P	AE12	AC6	AE6	AE13	M8	M4
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	186N	AE10	AC5	AE5	AE11	N8	M6
0	186P	AE8	AC4	AE4	AE9	P2	N6
0	187N	AE6	AC3	AE3	AE7	P8	M2
0	187P	AE4	AC2	AE2	AE5	N4	M1
0	188N	AE2	AC1	AE1	AE3	H1	N1
0	188P	AE0	AC0	AE0	AE1	J1	N2
-	GCLK0P	GCLK0	-	-	-	N7	N5
-	-	VCCJ	-	-	-	See Power Supply and NC Connections Table	
-	GCLK0N	GCLK1	-	-	-	P7	N3
-	-	GND	-	-	-	GND	GND
-	-	TDI	-	-	-	R1	P4
-	-	TMS	-	-	-	R2	P5

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	79N	N10	P5	N5	N11	-	V26
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	80P	N12	P6	N6	N13	-	V22
2	80N	N14	P7	N7	N15	-	V23
2	81P	N16	P8	N8	N17	-	V24
2	81N	N18	P9	N9	N19	-	V25
2	82P	N20	P10	N10	N21	-	U20
2	82N	N22	P11	N11	N23	-	T20
2	83P	N24	P12	N12	N25	-	U26
2	83N	N26	P13	N13	N27	-	U25
2	84P	N28	P14	N14	N29	-	U21
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	84N	N30	P15	N15	N31	-	T21
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	85P	P0	P16	N16	P1	-	U22
2	85N	P2	P17	N17	P3	-	U23
2	86P	P4	P18	N18	P5	-	U24
2	86N	P6	P19	N19	P7	-	T24
2	87P	P8	P20	N20	P9	-	T23
2	87N	P10	P21	N21	P11	-	T22
2	88P	P12	P22	N22	P13	-	T25
-	-	VCC	-	-	-	VCC	VCC
2	88N	P14	P23	N23	P15	-	R26
-	-	GND	-	-	-	GND	GND
2	89P	P16	P24	N24	P17	-	R25
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	89N	P18	P25	N25	P19	-	R24
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	90P	P20	P26	N26	P21	-	R21
2	90N	P22	P27	N27	P23	-	P21
2	91P	P24	P28	N28	P25	-	R22
2	91N	P26	P29	N29	P27	-	R23
2	92P	P28	P30	N30	P29	-	R20
2	92N	P30	P31	N31	P31	-	P20
-	-	TOE	-	-	-	W22	P25
-	-	RESET	-	-	-	V22	P24
-	-	GOE0	-	-	-	T22	P23
-	-	GOE1	-	-	-	R22	P22
-	-	GNDP	-	-	-	See Power Supply and NC Connections Table	
-	GCLK3N	GCLK2	-	-	-	P16	N26
-	-	VCCP	-	-	-	See Power Supply and NC Connections Table	

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
3	126N	W4	V11	U21	W5	B18	E19
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	126P	W6	V10	U20	W7	A18	E18
-	-	GND	-	-	-	GND	GND
3	127N	W8	V9	U18	W9	C17	C24
-	-	VCC	-	-	-	VCC	VCC
3	127P	W10	V8	U16	W11	B17	C23
3	128N	W12	V7	U12	W13	C16	D22
3	128P	W14	V6	U10	W15	B16	D21
3	129N	W16	V5	U8	W17	F13	E21
3	129P	W18	V4	U6	W19	F15	D20
3	130N	W20	V3	U5	W21	D16	D19
3	130P	W22	V2	U4	W23	E16	D18
3	131N	W24	V1	U2	W25	A16	C22
3	131P	W26	V0	U0	W27	A15	C21
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	132N	W28	X15	V15	W29	B15	C20
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	132P	W30	X14	V14	W31	A14	C19
3	133N	X0	X13	V13	X1	D15	C18
3	133P	X2	X12	V12	X3	E15	C17
3	134N	X4	X11	V11	X5	D14	B24
3	134P	X6	X10	V10	X7	F14	B23
3	135N	X8	X9	V9	X9	A13	B22
3	135P	X10	X8	V8	X11	B13	B21
3	136N	X12/VREF3	X29	V29	X13	C14	B20
3	136P	X14	X28	V28	X15	E14	B19
3	137N	X16	X7	V7	X17	E13	B18
3	137P	X18	X6	V6	X19	F12	B17
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	138N	X20	X5	V5	X21	D13	A24
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	138P	X22	X4	V4	X23	C13	A23
3	139N	X24	X3	V3	X25	E12	A22
-	-	GND	-	-	-	GND	GND
3	139P	X26	X2	V2	X27	C12	A21
-	-	VCC	-	-	-	VCC	VCC
3	140N	X28	X1	V1	X29	B12	A20
3	140P	X30	X0	V0	X31	A12	A19
0	141N	Y30	Y31	AA31	Y31	E11	A18
-	-	VCC	-	-	-	VCC	VCC
0	141P	Y28	Y30	AA30	Y29	C11	A17
-	-	GND	-	-	-	GND	GND

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
0	142N	Y26	Y29	AA29	Y27	B11	A10
0	142P	Y24	Y28	AA28	Y25	A11	A9
0	143N	Y22	Y27	AA27	Y23	F11	A8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	143P	Y20	Y26	AA26	Y21	F10	A7
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	144N	Y18	Y25	AA25	Y19	E10	A6
0	144P	Y16	Y24	AA24	Y17	C10	A5
0	145N	Y14/VREF0	Y3	AA3	Y15	D10	A4
0	145P	Y12	Y2	AA2	Y13	B10	A3
0	146N	Y10	Y23	AA23	Y11	A10	B10
0	146P	Y8	Y22	AA22	Y9	A9	B9
0	147N	Y6	Y21	AA21	Y7	C9	B8
0	147P	Y4	Y20	AA20	Y5	D9	B7
0	148N	Y2	Y19	AA19	Y3	F9	B6
0	148P	Y0	Y18	AA18	Y1	E9	B5
0	149N	Z30	Y1	AA1	Z31	A8	B4
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	149P	Z28	Y0	AA0	Z29	B8	B3
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	150N	Z26	AA29	-	Z27	A7	C10
0	150P	Z24	AA28	-	Z25	B7	C9
0	151N	Z22	AA27	-	Z23	A5	C8
0	151P	Z20	AA26	-	Z21	B5	C7
0	152N	Z18	AA25	-	Z19	B6	C6
0	152P	Z16	AA24	-	Z17	C7	C5
0	153N	Z14	AA23	-	Z15	E8	C4
0	153P	Z12	AA22	-	Z13	E7	D5
0	154N	Z10	AA21	-	Z11	E6	D9
-	-	VCC	-	-	-	VCC	VCC
0	154P	Z8	AA20	-	Z9	D6	D8
-	-	GND	-	-	-	GND	GND
0	155N	Z6	AA19	-	Z7	D8	D7
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	155P	Z4	AA18	-	Z5	F8	D6
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	156N	Z2	AA17	-	Z3	F7	F9
0	156P	Z0	AA16	-	Z1	D7	E9
0	157N	AA30	AA15	-	AA31	C6	F7
0	157P	AA28	AA14	-	AA29	C5	F8
0	158N	AA26	AA13	-	AA27	C4	G8
0	158P	AA24	AA12	-	AA25	D5	G9

Global Clock LVDS pair options: GCLK0 and GCLK1, as well as GCLK2 and GCLK3, can be paired together to receive differential clocks; where GCLK0 and GCLK3 are the positive LVDS inputs.

**SELECT DEVICES
DISCONTINUED**

ispXPLD 5000MV (3.3V) Lead-Free Commercial Devices (Continued)

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5512MV	LC5512MV-45QN208C	512	3.3	4.5	Lead-free PQFP	208	149	C
	LC5512MV-75QN208C	512	3.3	7.5	Lead-free PQFP	208	149	C
	LC5512MV-45FN256C	512	3.3	4.5	Lead-free fpBGA	256	193	C
	LC5512MV-75FN256C	512	3.3	7.5	Lead-free fpBGA	256	193	C
	LC5512MV-45FN484C	512	3.3	4.5	Lead-free fpBGA	484	253	C
	LC5512MV-75FN484C	512	3.3	7.5	Lead-free fpBGA	484	253	C
LC5768MV	LC5768MV-5FN256C	768	3.3	5.0	Lead-free fpBGA	256	193	C
	LC5768MV-75FN256C	768	3.3	7.5	Lead-free fpBGA	256	193	C
	LC5768MV-5FN484C	768	3.3	5.0	Lead-free fpBGA	484	317	C
	LC5768MV-75FN484C	768	3.3	7.5	Lead-free fpBGA	484	317	C
LC51024MV	LC51024MV-52FN484C	1024	3.3	5.2	Lead-free fpBGA	484	317	C
	LC51024MV-75FN484C	1024	3.3	7.5	Lead-free fpBGA	484	317	C
	LC51024MV-52FN672C	1024	3.3	5.2	Lead-free fpBGA	672	381	C
	LC51024MV-75FN672C	1024	3.3	7.5	Lead-free fpBGA	672	381	C

ispXPLD 5000MV (3.3V) Lead-Free Industrial Devices

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MV	LC5256MV-5FN256I	256	3.3	5.0	Lead-free fpBGA	256	141	I
	LC5256MV-75FN256I	256	3.3	7.5	Lead-free fpBGA	256	141	I
LC5512MV	LC5512MV-75QN208I	512	3.3	7.5	Lead-free PQFP	208	149	I
	LC5512MV-75FN256I	512	3.3	7.5	Lead-free fpBGA	256	193	I
	LC5512MV-75FN484I	512	3.3	7.5	Lead-free fpBGA	484	253	I
LC5768MV	LC5768MV-75FN256I	768	3.3	7.5	Lead-free fpBGA	256	193	I
	LC5768MV-75FN484I	768	3.3	7.5	Lead-free fpBGA	484	317	I
LC51024MV	LC51024MV-75FN484I	1024	3.3	7.5	Lead-free fpBGA	484	317	I
	LC51024MV-75FN672I	1024	3.3	7.5	Lead-free fpBGA	672	381	I

For Further Information

In addition to this data sheet, the following technical notes may be helpful when designing with the ispXPLD 5000MX family:

- TN1000 – [sysIO Usage Guidelines for Lattice Devices](#)
- TN1003 – [sysCLOCK PLL Usage Guide for ispXPGA, ispGDX2, ispXPLD and ispMACH 5000VG Devices](#)
- TN1031 – [Power Estimation in ispXPLD 5000MX Devices](#)
- TN1030 – [Using Memory in ispXPLD 5000MX Devices](#)
- TN1026 – [ispXP Configuration Usage Guidelines](#)